CUSTOMER: Texas Instruments

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**ART FILM - BOTTOM**
| CUSTOMER:  | Texas Instruments |
| BOARD NAME: | BBB-LP ADAPTER |
| PROJECT NUMBER: | WCS013 |
| LAYER DESCRIPTION: | Soldermask-Top |
| BOARD REV: | A |
| RELEASE DATE: | 2016-09-29 |
| SHEET NUMBER: | 5 of 10 |
CUSTOMER:
Texas Instruments

BOARD NAME:
BBB-LP ADAPTER

PROJECT NUMBER:
WCS013

LAYER DESCRIPTION:
Silkscreen-Bottom

BOARD REV:
A

RELEASE DATE:
2016-09-29

SHEET NUMBER:
8 of 10
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ASSEMBLY NOTES:
1. Connectors P1 and P2 should be mounted on Bottom side. The pins of the connectors should appear on the TOP side.
2. Connectors J8 and J9 should be mounted on Bottom side. The long pins of the connectors should appear on the BOTTOM side.

CUSTOMER: Texas Instruments
BOARD NAME: BBB-LP ADAPTER
PROJECT NUMBER: WCS013

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<th>LAYER DESCRIPTION:</th>
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<tr>
<td>SHEET NUMBER:</td>
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</table>
ASSEMBLY NOTES:
1. Connectors P1 and P2 should be mounted on Bottom side. The pins of the connectors should appear on the TOP side.
2. Connectors J8 and J9 should be mounted on Bottom side. The long pins of the connectors should appear on the BOTTOM side.
ART FILM - FABRICATION-DRAWING

854 4 4
PLATED
PLATED
PLATED
PLATED
PLATED
PLATED
PLATED
PLATED

2.15
1.00
QTY

TOLERANCE

+3.0/-3.0
+3.0/-3.0
+3.0/-3.0
+3.0/-3.0
+3.0/-3.0
+3.0/-3.0
+3.0/-3.0
+3.0/-3.0

DRILL CHART: TOP to BOTTOM
ALL UNITS ARE IN MILS

FIGURE
+   -

PLATED
PLATED
PLATED
PLATED
PLATED
PLATED

SIZE
10.0 15.0 39.37 41.34 43.31 125.0

+  -  ▲  ●  ●  ●

TOLERANCE
+3.0/-3.0 +3.0/-3.0 +3.0/-3.0 +3.0/-3.0 +3.0/-3.0 +3.0/-3.0

CUSTOMER:
Texas Instruments

BOARD NAME:
BBB-LP ADAPTER

LAYER DESCRIPTION:
Fabrication Drawing

PROJECT NUMBER:
WC5013

BOARD REV:
A

RELEASE DATE:
2016-09-29

SHEET NUMBER:
1 of 1

FAB NOTES:
1. ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE NOTED.
2. ART FILM - FABRICATION DRAWING
3. DIMENSIONS SHOWN ARE CENTER TO CENTER UNLESS OTHERWISE NOTED.
4. BOARD MATERIALS: BOARD MATERIALS TO BE FABRICATED TO IPC-6012, OTHERWISE NOTED.
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CUSTOMER:
Texas Instruments

BOARD NAME:
BBB-LP ADAPTER

LAYER DESCRIPTION:
Fabrication Drawing

PROJECT NUMBER:
WC5013

BOARD REV:
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